

	L #	Hits	Search Text	DBs	Time Stamp
1	L1	6431	((427/554-556, 98, 304-306) or (216/65, 94) or (219/121.69, 121.71) or (205/92, 126, 136)).CCL S.	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/09/16 12:59
2	L2	22511	(laser ligh adj(ray beam)) near (ablat\$4 drill\$4 etch\$4 remov\$4)	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/09/16 13:03
3	L3	918	1 and 2	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/09/16 13:03
4	L4	3640	2 same (plat\$4 electroless\$3)	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/09/16 13:05

~~L7~~
~~L6~~ (11) 5 and ~~aromatic~~
~~L8~~ (143) 6 not 7

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 and finally

09/029, 435

Sid. 12/18/01

L7

L7-1

	Document ID	Issue Date	Title	Current OR	Inventor
1	US 2002007 6497 A1	20020620	Method of forming selective electroless plating on polymer surfaces	427/304	Chen, William T. et al.
2	US 2002002 3906 A1	20020228	Method of producing through-hole in aromatic polyimide film	219/121.71	Yamamoto, Tomohiko et al.
3	US 6596968 B2	20030722	Method of producing through-hole in aromatic polyimide film	219/121.71	Yamamoto, Tomohiko et al.
4	US 6582581 B1	20030624	Sequential build circuit board plating process	205/125	Goldberg, Robert L. et al.
5	US 6362453 B1	20020326	Method of etching transparent solid material with laser beam	219/121.69	Wang, Jun et al.

LF-2

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	Document ID	Issue Date	Title	Current OR	Inventor
6	US 5703631 A	19971230	Method of forming an orifice array for a high density ink jet printhead	347/47	Hayes, Donald J. et al.
7	US 5487852 A	19960130	Laser-machining polymer s	264/400	Ludden, Michael J. et al.
8	US 5242713 A	19930907	Method for conditioning an organic polymer material	427/304	Viehbeck, Alfred et al.
9	US 5135779 A	19920804	Method for conditioning an organic polymer material	427/304	Viehbeck, Alfred et al.

LF-3

	Document ID	Issue Date	Title	Current OR	Inventor
10	US 4882200 A	19891121	Method for photopatterning metallization via UV-laser ablation of the activator	427/555	Liu, Yung S. et al.
11	US 4789770 A	19881206	Controlled depth laser drilling system	219/121.7	Kasner, William H. et al.

AP Laser ablation activator then plate